

## GFP 50N06

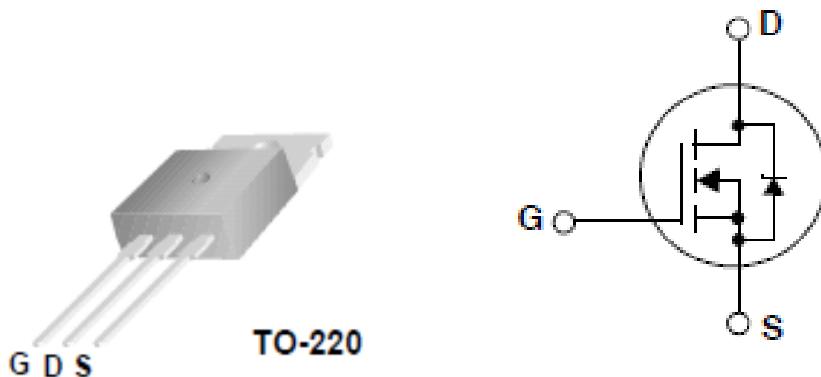
### FEATURES (参数)

**Low RD<sub>s(on)</sub> (0.023 Ω )@Vgs=10V**

**Low Gate Charge (Typical 39 nC)**

**Low Crss (typical 110 pF)**

**Maximum Junction Temperature range (175 °C)**



**Absolute maximum ratings T=25°C unless otherwise noted**

Characteristics	Symbol	Value	Units
Drain-Source Voltage	BV <sub>DSS</sub>	60	V
Drain Current	I <sub>D</sub>	50	A
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Single Pulsed Avalanche Energy	E <sub>AS</sub>	470	mJ
Power Dissipation	P <sub>D</sub>	130	W
Operating and Storage Temperature Range	T <sub>STG</sub>	-55 – 175	°C
Thermal Resistance ,Junction-to Case	R <sub>θ JC</sub>	1.15	°C/W
Drain-source Diode Forward Voltage	V <sub>SD</sub>	1.4	V

Parameter	Symbol	Min	Typ.	Max	Units	Test conditions
Gate threshold voltage	V <sub>GS(th)</sub>	2.0	-	4.0	V	V <sub>DS</sub> =V <sub>GS</sub> I <sub>D</sub> =250μA
Gate-Body leakage Current	I <sub>GSS</sub>	-	-	±100	nA	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V
Zero Gate voltage Drain current	I <sub>DSS</sub>	-	-	10	μA	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V
Static drain-source on-resistance	R <sub>DS(on)</sub>	-	18	23	mΩ	V <sub>GS</sub> =10V , I <sub>D</sub> =25A
Input capacitance	C <sub>iss</sub>	-	880	1140	pF	V <sub>GS</sub> =0V,V <sub>DS</sub> =25V, F=1.0MHZ
Output capacitance	C <sub>oss</sub>	-	430	560		
Reverse transfer capacitance	C <sub>rss</sub>	-	110	140		
Turn-on delay time	t <sub>d (on)</sub>	-	60	130	ns	V <sub>DD</sub> =30V,I <sub>D</sub> =25A, R <sub>G</sub> =50 Ω
Turn-on rise time	t <sub>r</sub>	-	185	380		
Turn-off delay time	t <sub>d (off)</sub>	-	75	160		
Turn-off fall time	t <sub>f</sub>	-	60	130		
Total Gate charge	Q <sub>g</sub>	-	39	45	nC	V <sub>DS</sub> =48V,V <sub>GS</sub> =10V, I <sub>D</sub> =50A,
Gate-source charge	Q <sub>gs</sub>	-	9.5	-		
Gate-drain charge	Q <sub>gd</sub>	-	1.3	-		